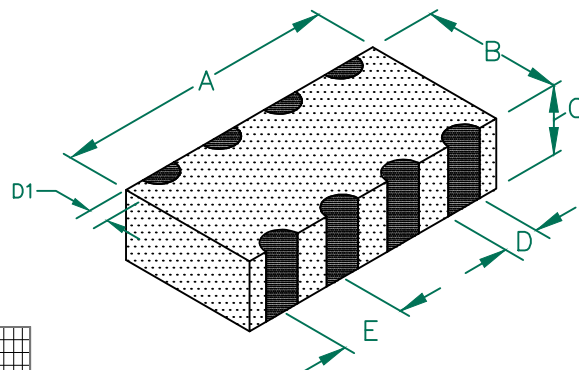


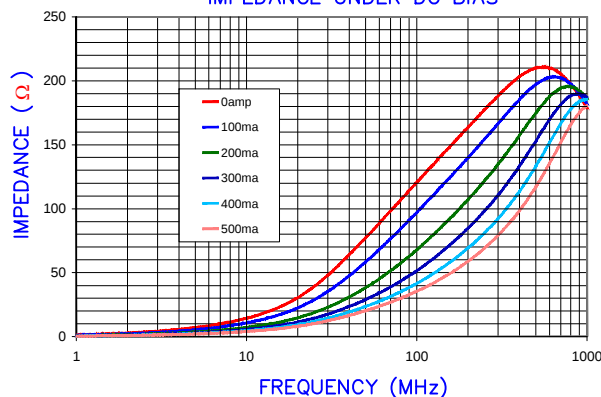
DA1206C121R-10

PHYSICAL DIMENSIONS:

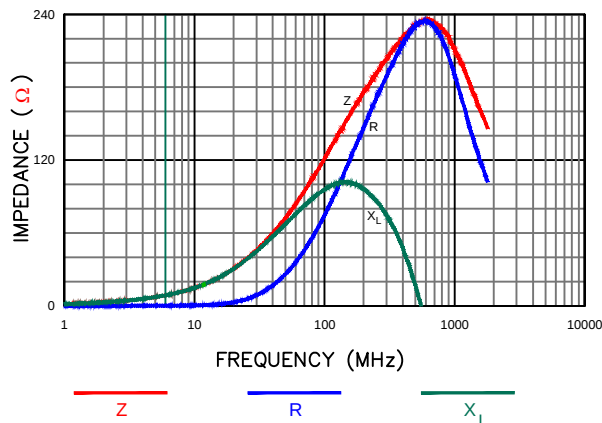
A	3.20 [.126]	+ 0.200 [.008]
B	1.60 [.063]	+ 0.200 [.008]
C	0.80 [.031]	+ 0.200 [.008]
D	0.40 [.016]	+ 0.150 [.006]
D1	0.30 [.012]	+ 0.200 [.008]
E	0.80 [.031]	+ 0.100 [.004]



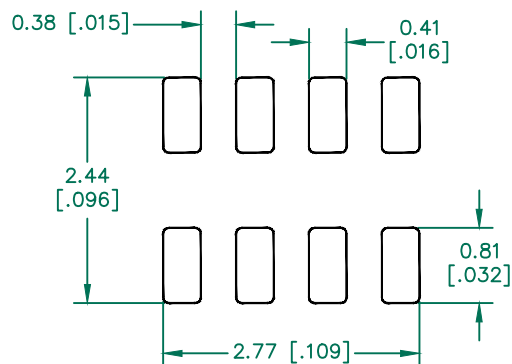
Z vs FREQUENCY
IMPEDANCE UNDER DC BIAS



|Z|, R, AND X vs. FREQUENCY



LAND PATTERNS FOR REFLOW SOLDERING



(For wave soldering, add 0.762 (0.030) to this dimension)

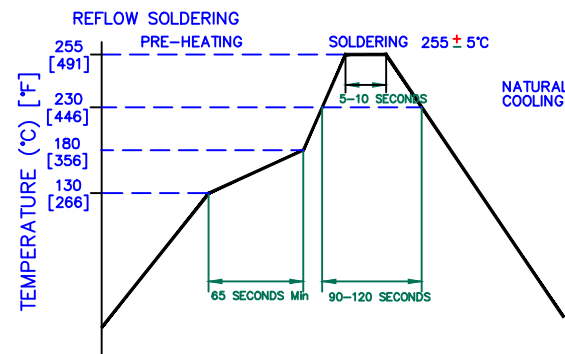
ELECTRICAL CHARACTERISTICS:

Z @ 100MHz (Ω)	DCR (Ω)	Rated Current
Nominal	120	
Minimum	90	
Maximum	150	0.2
300 mA		
LINE TO LINE INSULATION RESISTANCE >100 M Ω AT 75 VOLTS.		

NOTES: UNLESS OTHERWISE SPECIFIED

1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 7" REELS, 3000 PCS/REEL.
2. TERMINATION FINISH IS 100% TIN.
3. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
4. OPERATING TEMPERATURE TEMP: $-40^{\circ}\text{C} \sim +125^{\circ}\text{C}$ (INCLUDING SELF-HEATING)

RECOMMENDED SOLDERING CONDITIONS



DIMENSIONS ARE IN mm [INCHES].

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D	OPERATING TEMPERATURE UPDATE LAIRD LOGO AND REFLOW CURVE	08/05/13	QU	PROJECT/PART NUMBER: DA1206C121R-10
C	UPDATE COMPANY LOGO ADD ROHS	05/20/09	JRK	REV D
B	D1 dim chgd from 0.008 ± 0.004 to 0.012 ± 0.008. UPDATE COMPANY LOGO	10/30/07	JRK	PART TYPE: CO-FIRE
A	ORIGINAL DRAFT	03/30/04	TMB	DRAWN BY: TMB
REV	DESCRIPTION	DATE	INT	DATE: 03/30/04
DA1206C121R-10-D			SCALE: NTS	SHEET: 1 of 1

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